

December 2010 UniFET-II

# FDD7N60NZ / FDU7N60NZ N-Channel MOSFET 600V, 5.5A, 1.25 $\Omega$

#### **Features**

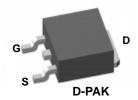
- $R_{DS(on)} = 1.05\Omega$  ( Typ.)@  $V_{GS} = 10V$ ,  $I_D = 2.75A$
- Low Gate Charge (Typ. 13nC)
- Low C<sub>rss</sub> (Typ. 7pF)
- · Fast Switching
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Improved Capability
- RoHS Compliant



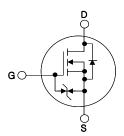
# **Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.







## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter		FDD7N60NZ/FDU7N60NZ	Units
V <sub>DSS</sub>	Drain to Source Voltage			600	V
$V_{GSS}$	Gate to Source Voltage			±25	V
	Drain Current	-Continuous (T <sub>C</sub> = 25°C)		5.5	_
ID	Diain Current	-Continuous (T <sub>C</sub> = 100°C)		3.3	Α
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	22	Α
E <sub>AS</sub>	Single Pulsed Avalanche En	ergy	(Note 2)	347	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	5.5	Α
E <sub>AR</sub>	Repetitive Avalanche Energ	у	(Note 1)	12.5	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10	V/ns
D	Dower Discipation	(T <sub>C</sub> = 25°C)		90	W
$P_{D}$	Power Dissipation	- Derate above 25°C		0.7	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tem	perature Range		-55 to +150	οС
T <sub>L</sub>	Maximum Lead Temperature 1/8" from Case for 5 Second	<b>0</b> ,		300	°C

#### **Thermal Characteristics**

Symbol	Parameter FDD7N60NZ/FDU7N60NZ		Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case 1.4		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	90	G/ VV

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD7N60NZ	FDD7N60NZ	D-PAK	380mm	16mm	2500
FDU7N60NZ	FDU7N60NZ	I-PAK	-	-	70

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Units
Off Charac	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A$ , $V_{GS} = 0 V$ , $T_J = 25 ^{\circ} C$	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.6	-	V/°C
	Zoro Coto Voltogo Proin Current	$V_{DS} = 600V, V_{GS} = 0V$	-	-	50	^
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 480V, T_{C} = 125^{\circ}C$	-	-	100	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 25V, V_{DS} = 0V$	-	-	±10	μΑ

#### **On Characteristics**

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\mu A$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 2.75A$	-	1.05	1.25	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20V, I_D = 2.75A$ (Note 4)	ı	7.3	İ	S

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1MHz		550	730	pF
C <sub>oss</sub>	Output Capacitance			70	90	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	-	-	7	10	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		-	13	17	nC
$Q_{gs}$	Gate to Source Gate Charge	$V_{DS} = 400V I_{D} = 5.5A$	-	3	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge	V <sub>GS</sub> = 10V (Note 4, 5)	-	5.6	-	nC

# **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		-	17.5	45	ns
t <sub>r</sub>		$V_{DD} = 250V, I_{D} = 5.5A$	-	30	70	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_G = 25\Omega$	-	40	90	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4, 5)	-	25	60	ns

### **Drain-Source Diode Characteristics**

IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	5.5	Α	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	22	Α	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{SD} = 5.5A$		-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0V, I_{SD} = 5.5A$		-	250	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	(Note 4)	-	1.4	-	μС

#### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 23mH, I  $_{AS}$  = 5.5A, V  $_{DD}$  = 50V, R  $_{G}$  = 25 $\!\Omega$ , Starting T  $_{J}$  = 25 $^{\circ}C$
- 3. I  $_{SD} \leq 5.5 A, \ di/dt \leq 200 A/\mu s, \ V_{DD} \leq BV_{DSS}, \ Starting \ T_J = 25^{\circ}C$
- 4. Pulse Test: Pulse width  $\leq 300\mu s$ , Dual Cycle  $\leq 2\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

# **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

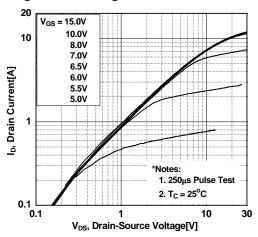


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

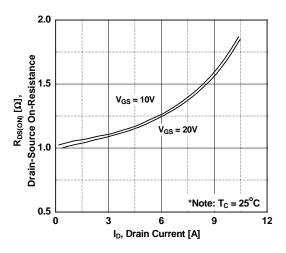


Figure 5. Capacitance Characteristics

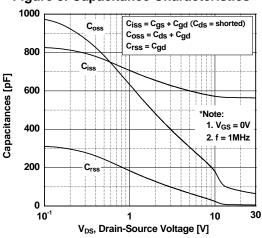


Figure 2. Transfer Characteristics

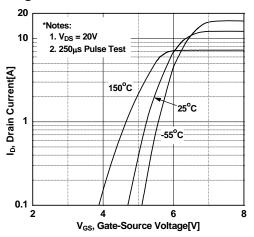


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

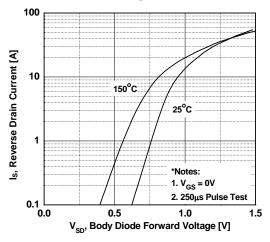
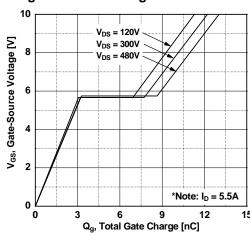


Figure 6. Gate Charge Characteristics



# **Typical Performance Characteristics (Continued)**

Figure 7. Breakdown Voltage Variation vs. Temperature

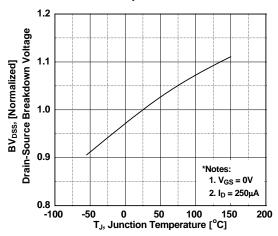


Figure 9. Maximum Safe Operating Area vs. Case Temperature

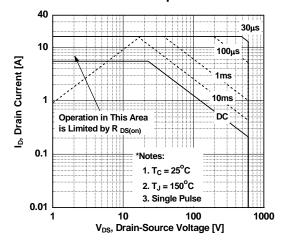


Figure 8. On-Resistance Variation vs. Temperature

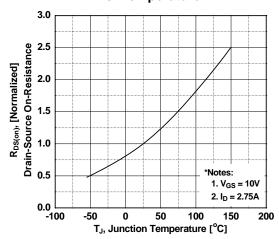


Figure 10. Maximum Drain Current

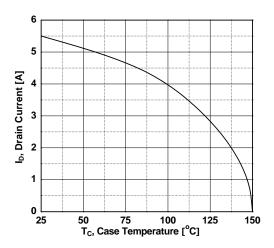
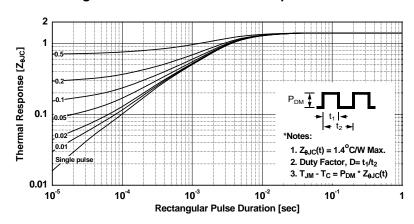
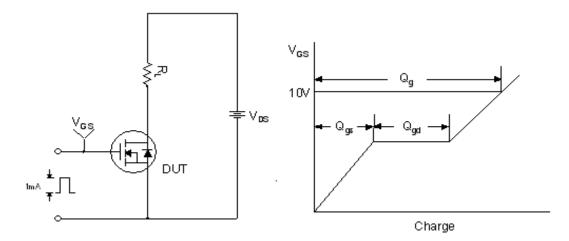


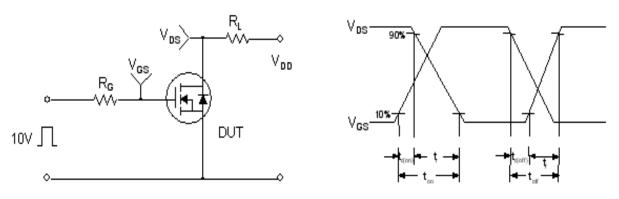
Figure 11. Transient Thermal Response Curve



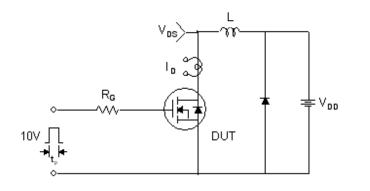
## **Gate Charge Test Circuit & Waveform**

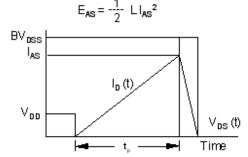


#### **Resistive Switching Test Circuit & Waveforms**

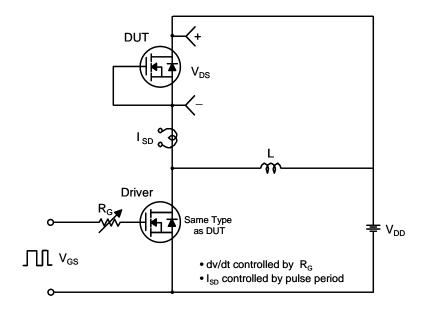


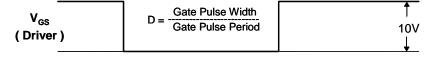
**Unclamped Inductive Switching Test Circuit & Waveforms** 

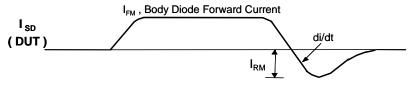




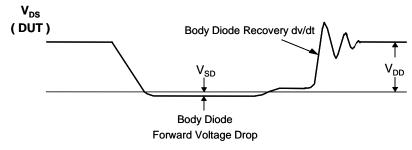
#### Peak Diode Recovery dv/dt Test Circuit & Waveforms





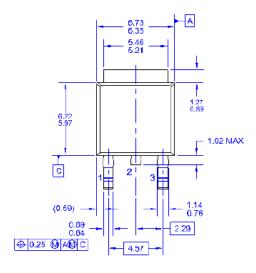


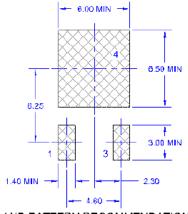
Body Diode Reverse Current



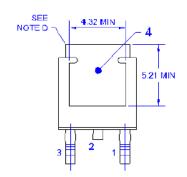
#### **Mechanical Dimensions**

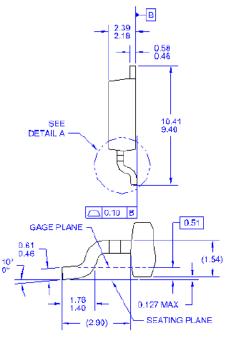
# **D-PAK**





LAND PATTERN RECOMMENDATION





- NOTES: LINLESS OTHERWISE SPECIFIED

  A) THIS PACKAGE CONFORMS TO JEDEC, TO-252.
  ISSUE C, VARIATION AA.

  B) ALL DINENSIONS ARE IN MILLIMETERS.
  C) DIMENSIONING AND TOLENANCING PER ASME Y1-4.5M-1934.

  D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.
  E) PRESENCE OF TRIMMED CENTER LEAD IS COTIONAL.

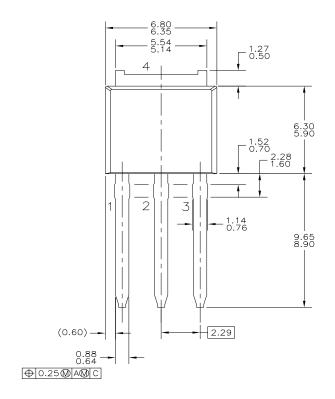
  F) DIMENSIONS ARE EXCLUSSIVE OF BURSS, WOLD FLASH AND THE BAR EX HAUSTONS.
  D) LAND PATTERN RECOMENDATION IS BASED ON IPC7351A STD TO22071003X236-2N.

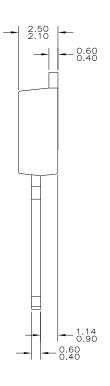
  H) DRAWING NUMBER AND REVISION: WKT-TO252A03REVB

**Dimensions in Millimeters** 

# **Mechanical Dimensions**

# I-PAK







8

Dimensions in Millimeters





SYSTEM \*\*

GENERAL

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bwer

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